



SPECIFICATION

(Reference sheet)

· Supplier : Samsung electro-mechanics · Samsung P/N: CL05A224KP5NNWC

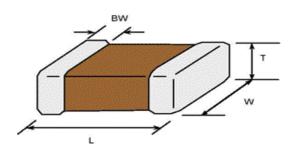
· Product : Multi-layer Ceramic Capacitor · Description : CAP, 220nF, 10V, ±10%, X5R, 0402

A. Samsung Part Number

<u>CL</u> <u>05</u> <u>A</u> <u>224</u> <u>K</u> <u>P</u> <u>5</u> <u>N</u> <u>N</u> <u>W</u> <u>C</u> 1 2 3 4 5 6 7 8 9 10 11

1	Series	Samsung Multi-layer Ceramic Capacitor					
2	Size	0402 (inch code)	L: 1.00	± 0.05 mm	W:	$0.50\pm0.05~\text{mm}$	
3	Dielectric	X5R	8	Inner electrode		Ni	
4	Capacitance	220 nF		Termination		Cu	
(5)	Capacitance	±10 %		Plating		Sn 100% (Pb Free	e)
	tolerance		9	Product		Normal	
6	Rated Voltage	10 V	10	Special		Industrial (Network,etc)	
7	Thickness	$0.50 \pm 0.05 \text{ mm}$	11)	Packaging		Cardboard Type, 7" ree	el .

B. Structure & Dimension



Samsung P/N	Dimension(mm)					
Samsung F/N	L	W	Т	BW		
CL05A224KP5NNWC	1.00 ± 0.05	0.50 ± 0.05	0.50 ± 0.05	0.25 ± 0.10		

C. Samsung Reliablility Test and Judgement Condition

	Judgement	Test condition			
Capacitance	Within specified tolerance	1kHz ±10% / 1.0±0.2Vrms			
Tan δ (DF)	0.05 max.	*A capacitor prior to measuring the capacitance is heat treated at 150 ℃ +0/-10 ℃ for 1hour and maintained in ambient air for 24±2 hours.			
Insulation	10,000Mohm or 100Mohm× <i>μ</i> F	Rated Voltage 60~120 sec			
Resistance	Whichever is smaller				
Appearance No abnormal exterior appearance		Microscope (×10)			
Withstanding	No dielectric breakdown or	250% of the rated voltage			
Voltage	mechanical breakdown				
Temperature	X5R				
Characteristics	(From -55℃ to 85℃, Capacitance change should be within ±15%)				
Adhesive Strength	No peeling shall be occur on the	500g·f, for 10±1 sec.			
of Termination	terminal electrode				
Bending Strength	Capacitance change : within ±12.5%	Bending to the limit (1mm) with 1.0mm/sec.			
Solderability	More than 75% of terminal surface is to be soldered newly	SnAg3.0Cu0.5 solder 245±5°C, 3±0.3sec. (preheating : 80~120°C for 10~30sec.)			
Resistance to	Capacitance change : within ±7.5%	Solder pot : 270±5°C, 10±1sec.			
Soldering Heat	Tan δ, IR: initial spec.				
Vibration Test	Capacitance change : within \pm 5% Tan δ , IR : initial spec.	Amplitude: 1.5mm From 10Hz to 55Hz (return: 1min.) 2hours × 3 direction (x, y, z)			
Moisture	Capacitance change: within ±12.5%	With rated voltage			
Resistance	Tan δ : 0.075 max IR : 500Mohm or 25Mohm×μF Whichever is smaller	40±2°C, 90~95%RH, 500+12/-0hrs			
High Temperature Resistance	Capacitance change: within ±12.5% Tan δ: 0.075 max IR: 1,000Mohm or 50Mohm×μF Whichever is smaller	With 200% of the rated voltage Max. operating temperature 1,000+48/-0hrs			
Temperature Cycling	Capacitance change : within ±7.5% Tan δ, IR : initial spec.	1 cycle condition Min. operating temperature → 25°C → Max. operating temperature → 25°C 5 cycle test			

D. Recommended Soldering method:

Reflow (Reflow Peak Temperature : 260±5 °C, 30sec.)



Product specifications included in the specifications are effective as of March 1, 2013.

Please be advised that they are standard product specifications for reference only.

We may change, modify or discontinue the product specifications without notice at any time.

So, you need to approve the product specifications before placing an order.

Should you have any question regarding the product specifications,

please contact our sales personnel or application engineers.

- Disclaimer & Limitation of Use and Application -

The products listed in this Specification sheet are **NOT** designed and manufactured for any use and applications set forth below.

Please note that any misuse of the products deviating from products specifications or information provided in this Spec sheet may cause serious property damages or personal injury.

We will **NOT** be liable for any damages resulting from any misuse of the products, specifically including using the products for high reliability applications as listed below.

If you have any questions regarding this 'Limitation of Use and Application', you should first contact our sales personnel or application engineers.

- ① Aerospace/Aviation equipment
- ② Automotive or Transportation equipment (vehicles, trains, ships, etc)
- 3 Medical equipment
- Military equipment
- 5 Disaster prevention/crime prevention equipment
- Any other applications with the same as or similar complexity or reliability to the applications set forth above.